

## Chapter 3 Basic Physics of Semiconductors

- 1 Semiconductor materials and their properties
- 2 PN-junction diodes
- 3 Reverse Breakdown

# Semiconductor Physics

## Semiconductors

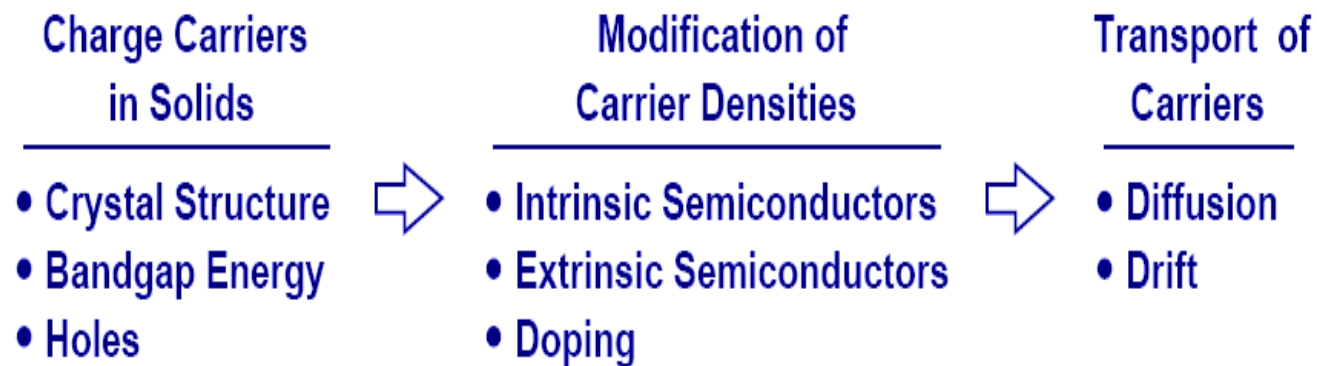
- Charge Carriers
- Doping
- Transport of Carriers

## PN Junction

- Structure
- Reverse and Forward Bias Conditions
- I/V Characteristics
- Circuit Models

- **Semiconductor devices serve as heart of microelectronics.**
- **PN junction is the most fundamental semiconductor device.**

## Charge Carriers in Semiconductor



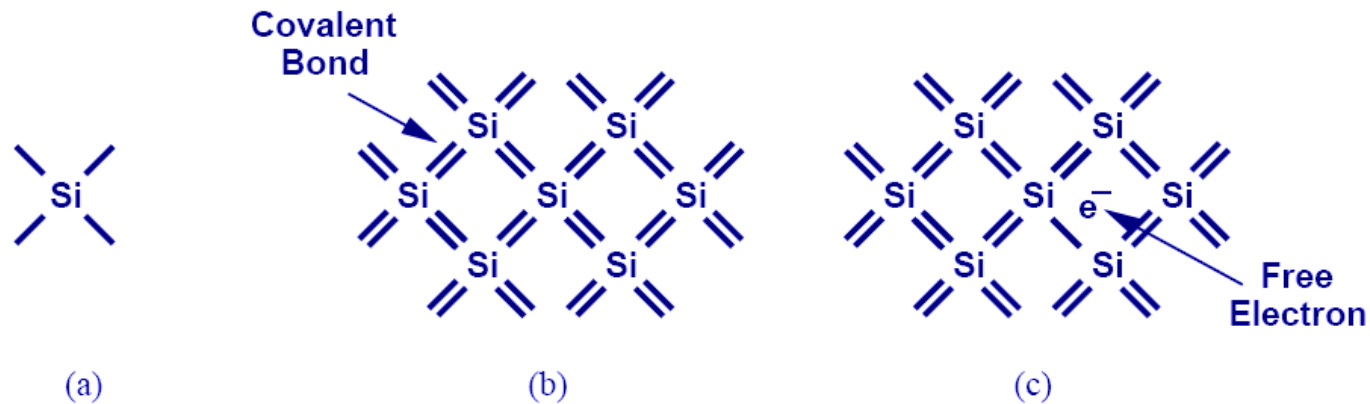
➤ **To understand PN junction's IV characteristics, it is important to understand charge carriers' behavior in solids, how to modify carrier densities, and different mechanisms of charge flow.**

## Periodic Table

	III	IV	V	
	Boron (B)	Carbon (C)		
• • •	Aluminum (Al)	Silicon (Si)	Phosphorous (P)	• • •
	Galium (Al)	Germanium (Ge)	Arsenic (As)	
		• • •		

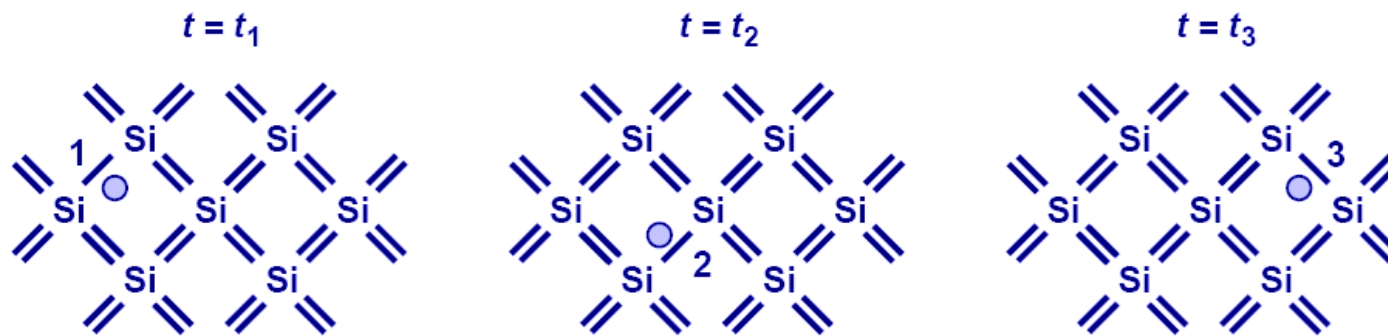
➤ This abridged table contains elements with three to five valence electrons, with Si being the most important.

# Silicon



- **Si has four valence electrons. Therefore, it can form covalent bonds with four of its neighbors.**
- **When temperature goes up, electrons in the covalent bond can become free.**

## Electron-Hole Pair Interaction



- **With free electrons breaking off covalent bonds, holes are generated.**
- **Holes can be filled by absorbing other free electrons, so effectively there is a flow of charge carriers.**

## Free Electron Density at a Given Temperature

$$n_i = 5.2 \times 10^{15} T^{3/2} \exp \frac{-E_g}{2kT} \text{ electrons / cm}^3$$

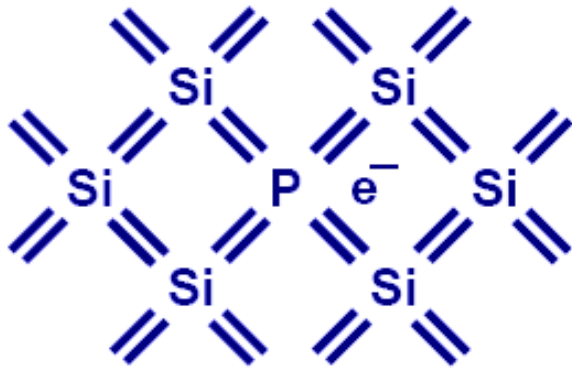
$$n_i(T = 300^0 K) = 1.08 \times 10^{10} \text{ electrons / cm}^3$$

$$n_i(T = 600^0 K) = 1.54 \times 10^{15} \text{ electrons / cm}^3$$

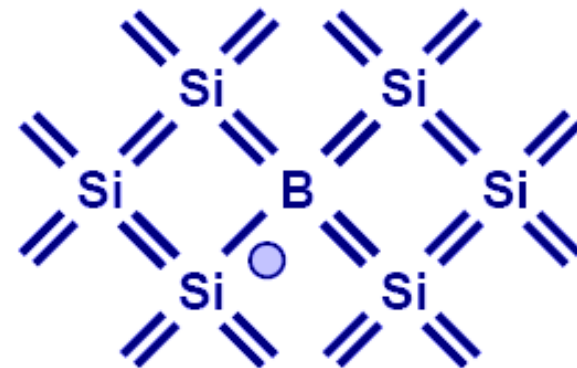
- $E_g$ , or bandgap energy determines how much effort is needed to break off an electron from its covalent bond.
- There exists an exponential relationship between the free-electron density and bandgap energy.

## Doping (N type and P type)

- Pure Si can be doped with other elements to change its electrical properties.



- If Si is doped with P (phosphorous), then it has more electrons, or becomes type N type.

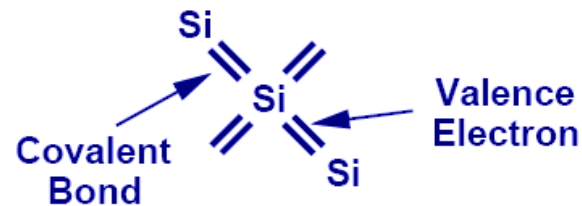


- If Si is doped with B (boron), then it has more holes, or becomes type P.



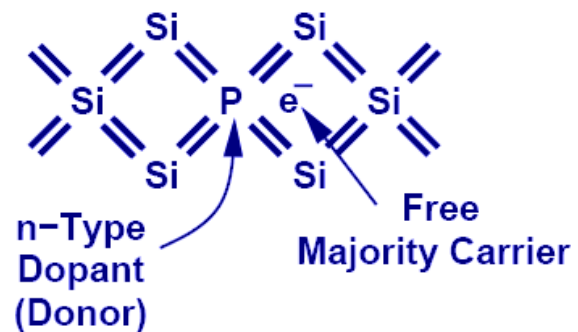
## Summary of Charge Carriers

### Intrinsic Semiconductor

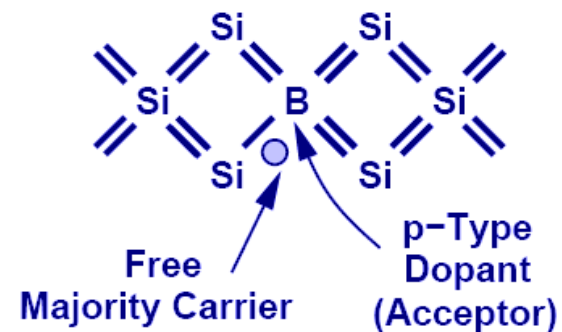


### Extrinsic Semiconductor

Silicon Crystal  
 $N_D$  Donors/cm<sup>3</sup>



Silicon Crystal  
 $N_A$  Acceptors/cm<sup>3</sup>



## Electron and Hole Densities

$$np = n_i^2$$

Majority Carriers :  $p \approx N_A$

Minority Carriers :  $n \approx \frac{n_i^2}{N_A}$

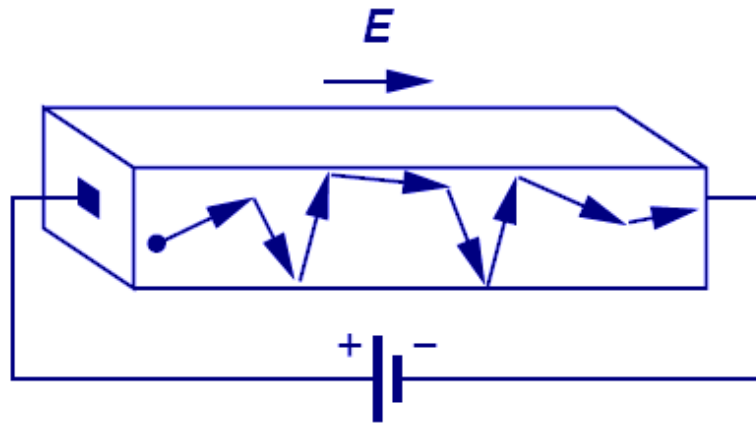
Majority Carriers :  $n \approx N_D$

Minority Carriers :  $p \approx \frac{n_i^2}{N_D}$

➤ **The product of electron and hole densities is ALWAYS equal to the square of intrinsic electron density regardless of doping levels.**

$$np = n_i^2$$

## First Charge Transportation Mechanism: Drift

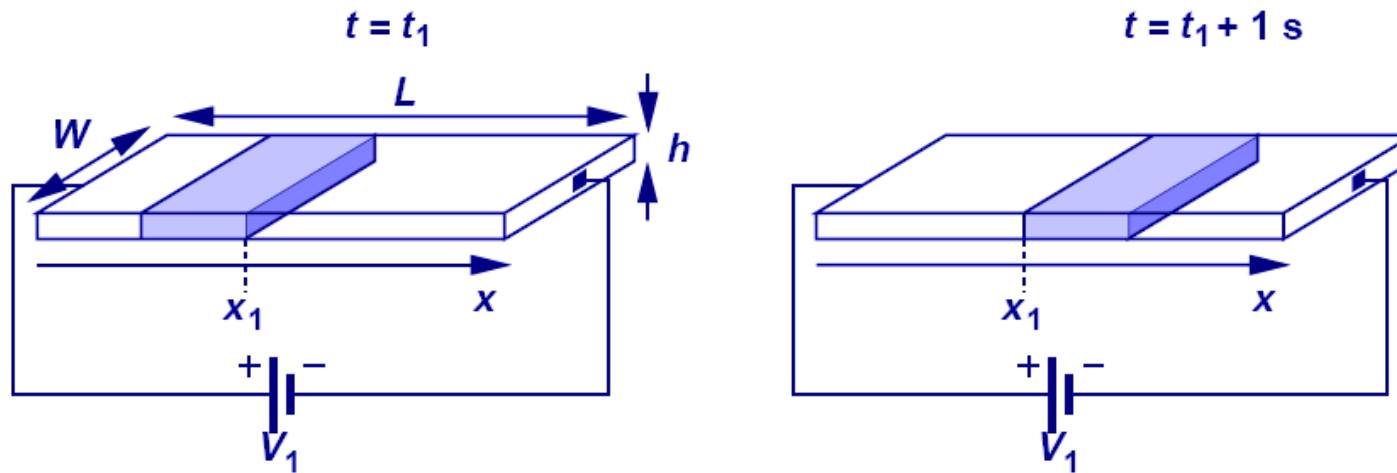


$$\vec{v}_h = \mu_p \vec{E}$$

$$\vec{v}_e = -\mu_n \vec{E}$$

- The process in which charge particles move because of an electric field is called drift.
- Charge particles will move at a velocity that is proportional to the electric field.

## Current Flow: General Case



$$I = -v \cdot W \cdot h \cdot n \cdot q$$

- Electric current is calculated as the amount of charge in  $v$  meters that passes thru a cross-section if the charge travel with a velocity of  $v$  m/s.

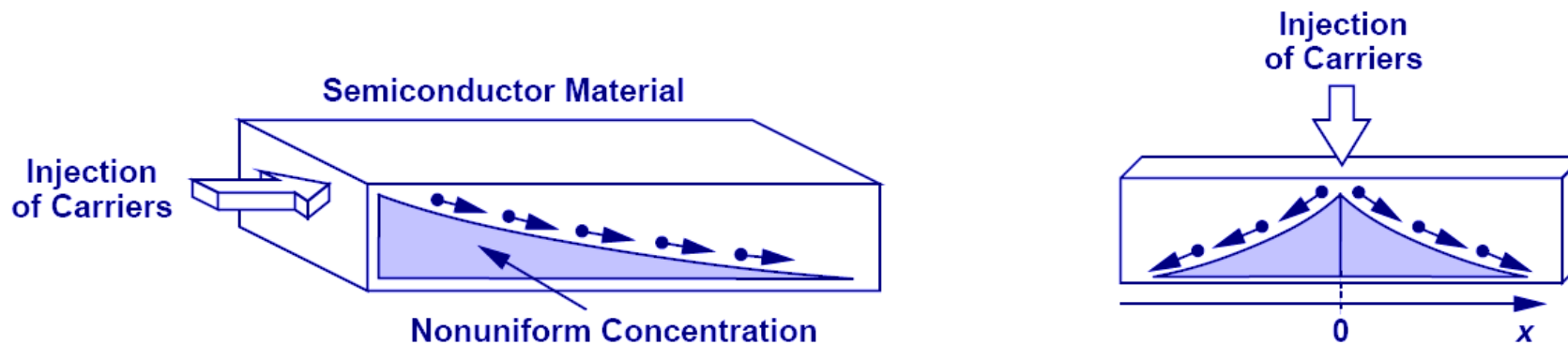
## Current Flow: Drift

$$J_n = \mu_n E \cdot n \cdot q$$

$$\begin{aligned} J_{tot} &= \mu_n E \cdot n \cdot q + \mu_p E \cdot p \cdot q \\ &= q(\mu_n n + \mu_p p)E \end{aligned}$$

- Since velocity is equal to  $\mu E$ , drift characteristic is obtained by substituting  $V$  with  $\mu E$  in the general current equation.
- The total current density consists of both electrons and holes.

## Second Charge Transportation Mechanism: Diffusion



- **Charge particles move from a region of high concentration to a region of low concentration. It is analogous to an every day example of an ink droplet in water.**

## Current Flow: Diffusion

$$I = AqD_n \frac{dn}{dx}$$

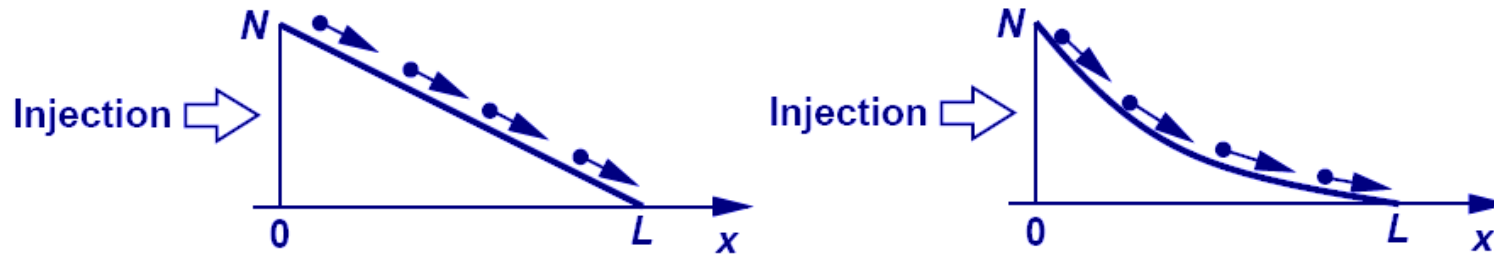
$$J_p = -qD_p \frac{dp}{dx}$$

$$J_n = qD_n \frac{dn}{dx}$$

$$J_{tot} = q(D_n \frac{dn}{dx} - D_p \frac{dp}{dx})$$

- Diffusion current is proportional to the gradient of charge ( $dn/dx$ ) along the direction of current flow.
- Its total current density consists of both electrons and holes.

## Example: Linear vs. Nonlinear Charge Density Profile



$$J_n = qD_n \frac{dn}{dx} = -qD_n \cdot \frac{N}{L}$$

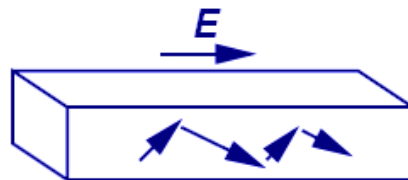
$$J_n = qD \frac{dn}{dx} = \frac{-qD_n N}{L_d} \exp \frac{-x}{L_d}$$

➤ **Linear charge density profile means constant diffusion current, whereas nonlinear charge density profile means varying diffusion current.**



## Einstein's Relation

Drift Current



$$J_n = q \mu_n E$$

$$J_p = q \mu_p E$$

Diffusion Current



$$J_n = q D_n \frac{dn}{dx}$$

$$J_p = -q D_p \frac{dp}{dx}$$

$$\frac{D}{\mu} = \frac{kT}{q}$$

➤ While the underlying physics behind drift and diffusion currents are totally different, Einstein's relation provides a mysterious link between the two.